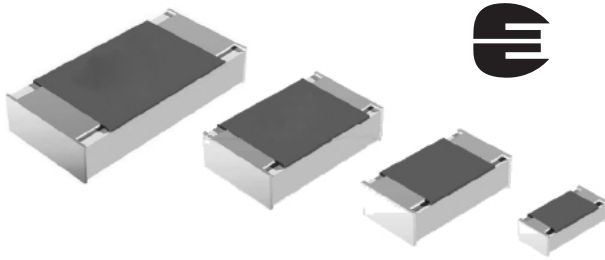




Professional Thin Film Chip Resistors



RoHS
COMPLIANT

FEATURES

- Approved to EN 140401-801
- Excellent overall stability: Class 0.5
- Professional tolerance of value: $\pm 0.5\%$ and $\pm 1\%$
- Lead (Pb)-free solder contacts
- Waste gas resistance verified by ASTM B 809
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Automotive
- Telecommunication
- Medical equipment
- Industrial equipment

MCS 0402, MCT 0603, MCU 0805 and MCA 1206 professional thin film flat chip resistors are the perfect choice for most fields of modern professional electronics where reliability and stability is of major concern. Typical applications include telecommunication, medical equipment and high-end computer and audio/video electronics.

TECHNICAL SPECIFICATIONS									
	MCS 0402		MCT 0603		MCU 0805		MCA 1206		
Imperial size	0402		0603		0805		1206		
Metric size code	RR1005M		RR1608M		RR2012M		RR3216M		
Resistance range	10 Ω to 4.99 M Ω ; 0 Ω		1 Ω to 10 M Ω ; 0 Ω		1 Ω to 10 M Ω ; 0 Ω		1 Ω to 2 M Ω ; 0 Ω		
Resistance tolerance	$\pm 1\%$; $\pm 0.5\%$								
Temperature coefficient	± 50 ppm/K; ± 25 ppm/K								
Operation mode	Standard	Power	Standard	Power	Standard	Power	Standard	Power	
Rated dissipation, P_{70} ⁽¹⁾	0.063 W	0.1 W	0.1 W	0.125 W	0.125 W	0.2 W	0.25 W	0.4 W	
Operating voltage, U_{max} , AC/DC	50 V		75 V		150 V		200 V		
Permissible film temperature, θ_f max.	125 $^{\circ}$ C	155 $^{\circ}$ C	125 $^{\circ}$ C	155 $^{\circ}$ C	125 $^{\circ}$ C	155 $^{\circ}$ C	125 $^{\circ}$ C	155 $^{\circ}$ C	
Operating temperature range	- 55 $^{\circ}$ C to 125 $^{\circ}$ C	- 55 $^{\circ}$ C to 155 $^{\circ}$ C	- 55 $^{\circ}$ C to 125 $^{\circ}$ C	- 55 $^{\circ}$ C to 155 $^{\circ}$ C	- 55 $^{\circ}$ C to 125 $^{\circ}$ C	- 55 $^{\circ}$ C to 155 $^{\circ}$ C	- 55 $^{\circ}$ C to 125 $^{\circ}$ C	- 55 $^{\circ}$ C to 155 $^{\circ}$ C	
Max. resistance change at P_{70} for resistance range, $ \Delta R/R $ max., after:	10 Ω to 4.99 M Ω		1 Ω to 10 M Ω		1 Ω to 10 M Ω		1 Ω to 2 M Ω		
	1000 h	$\leq 0.25\%$	$\leq 0.5\%$	$\leq 0.25\%$	$\leq 0.5\%$	$\leq 0.25\%$	$\leq 0.5\%$	$\leq 0.25\%$	$\leq 0.5\%$
	8000 h	$\leq 0.5\%$	$\leq 1.0\%$	$\leq 0.5\%$	$\leq 1.0\%$	$\leq 0.5\%$	$\leq 1.0\%$	$\leq 0.5\%$	$\leq 1.0\%$
	225 000 h	$\leq 1.5\%$	-	$\leq 1.5\%$	-	$\leq 1.5\%$	-	$\leq 1.5\%$	-
Insulation voltage:	75 V		100 V		200 V		300 V		
	1 min; U_{ins}	75 V	75 V	75 V	75 V	75 V	75 V	75 V	
Continuous	75 V		75 V		75 V		75 V		
Failure rate: FIT _{observed}	$\leq 0.1 \times 10^{-9}/h$		$\leq 0.1 \times 10^{-9}/h$		$\leq 0.1 \times 10^{-9}/h$		$\leq 0.1 \times 10^{-9}/h$		

Notes

- These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.
- (1) The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature is not exceeded.



PART NUMBER AND PRODUCT DESCRIPTION

Part Number: MCT06030D4641DPW00

M	C	T	0	6	0	3	0	D	4	6	4	1	D	P	W	0	0
---	---	---	---	---	---	---	---	---	---	---	---	---	---	---	---	---	---

TYPE/SIZE MCS0402 MCT0603 MCU0805 MCA1206	VERSION 0 = Neutral	TCR D = ± 25 ppm/K C = ± 50 ppm/K Z = Jumper	RESISTANCE 3 digit value 1 digit multiplier MULTIPLIER 8 = *10 ⁻² 9 = *10 ⁻¹ 0 = *10 ⁰ 1 = *10 ¹ 2 = *10 ² 3 = *10 ³ 4 = *10 ⁴ 5 = *10 ⁵ 0000 = Jumper	TOLERANCE D = ± 0.5 % F = ± 1 % Z = Jumper	PACKAGING P5 PW E0
-------------------------------------------------------	------------------------	-------------------------------------------------------	----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------	-----------------------------------------------------	-----------------------------

Product Description: MCT 0603-25 0.5 % PW 4K64

MCT	0603	-25	0.5 %	PW	4K64
TYPE MCS MCT MCU MCA	SIZE 0402 0603 0805 1206	TCR ± 25 ppm/K ± 50 ppm/K	TOLERANCE ± 0.5 % ± 1 %	PACKAGING P5 PW E0	RESISTANCE 4K64 = 4.64 kΩ 50R1 = 50.1 Ω 0R0 = Jumper ⁽¹⁾

Notes

- Products can be ordered using either the PRODUCT DESCRIPTION or PART NUMBER.
- ⁽¹⁾ Jumpers are ordered by the resistance value 0 Ω, e.g. MCT 0603 P5 0R0.

TEMPERATURE COEFFICIENT AND RESISTANCE RANGE

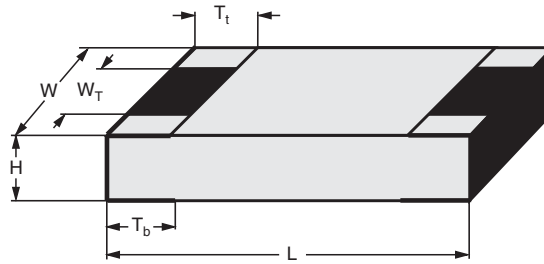
DESCRIPTION		RESISTANCE RANGE			
TCR	TOLERANCE	MCS 0402	MCT 0603	MCU 0805	MCA 1206
± 50 ppm/K	± 1 %	10 Ω to 4.99 MΩ	1 Ω to 10 MΩ	1 Ω to 10 MΩ	1 Ω to 2 MΩ
	± 0.5 %	10 Ω to 221 kΩ	10 Ω to 511 kΩ	10 Ω to 1.5 MΩ	10 Ω to 2 MΩ
± 25 ppm/K	± 0.5 %	10 Ω to 221 kΩ	10 Ω to 511 kΩ	10 Ω to 1.5 MΩ	10 Ω to 2 MΩ
Jumper	-	≤ 20 mΩ <i>I</i> _{max.} = 0.63 A	≤ 20 mΩ <i>I</i> _{max.} = 1 A	≤ 20 mΩ <i>I</i> _{max.} = 1.5 A	≤ 20 mΩ <i>I</i> _{max.} = 2 A

Notes

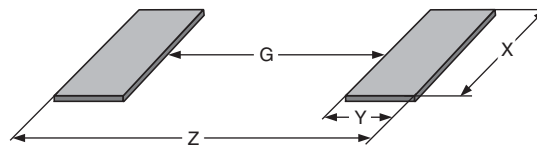
- Resistance values are available for ± 1 % tolerance from the E24 and E96 series; for ± 0.5 % tolerance from the E24 and E192 series.
- **Resistance ranges printed in bold are preferred TCR/tolerance combinations with optimized availability.**

PACKAGING

TYPE	CODE	QUANTITY	CARRIER TAPE	WIDTH	PITCH	REEL DIAMETER
MCS 0402	E0	10 000	Paper tape acc. IEC 60286-3 type I	8 mm	2 mm	180 mm/7"
MCT 0603	P5	5000				180 mm/7"
	PW	20 000			330 mm/13"	
MCU 0805	P5	5000			180 mm/7"	
	PW	20 000			330 mm/13"	
MCA 1206	P5	5000			180 mm/7"	

DIMENSIONS


DIMENSIONS AND MASS							
TYPE	H (mm)	L (mm)	W (mm)	W _T (mm)	T _t (mm)	T _b (mm)	MASS (mg)
MCS 0402	0.32 ± 0.05	1.0 ± 0.05	0.5 ± 0.05	> 75 % of W	0.2 + 0.1/- 0.15	0.2 ± 0.1	0.6
MCT 0603	0.45 + 0.1/- 0.05	1.55 ± 0.05	0.85 ± 0.1	> 75 % of W	0.3 + 0.15/- 0.2	0.3 + 0.15/- 0.2	1.9
MCU 0805	0.45 + 0.1/- 0.05	2.0 ± 0.1	1.25 ± 0.15	> 75 % of W	0.4 + 0.1/- 0.2	0.4 + 0.1/- 0.2	4.6
MCA 1206	0.55 ± 0.1	3.2 + 0.1/- 0.2	1.6 ± 0.15	> 75 % of W	0.5 ± 0.25	0.5 ± 0.25	9.2

SOLDER PAD DIMENSIONS


RECOMMENDED SOLDER PAD DIMENSIONS								
TYPE	WAVE SOLDERING				REFLOW SOLDERING			
	G (mm)	Y (mm)	X (mm)	Z (mm)	G (mm)	Y (mm)	X (mm)	Z (mm)
MCS 0402	-	-	-	-	0.35	0.55	0.55	1.45
MCT 0603	0.55	1.10	1.10	2.75	0.65	0.70	0.95	2.05
MCU 0805	0.80	1.25	1.50	3.30	0.90	0.90	1.40	2.70
MCA 1206	1.40	1.50	1.90	4.40	1.50	1.15	1.75	3.80

Note

- The rated dissipation applies only if the permitted film temperature is not exceeded. Furthermore, a high level of ambient temperature or of power dissipation may raise the temperature of the solder joint, hence special solder alloys or board materials may be required to maintain the reliability of the assembly.

Specified power rating above 125 °C requires dedicated heat-sink pads, which depend on board materials.

The given solder pad dimensions reflect the considerations for board design and assembly as outlined e.g. in standards IEC 61188-5-x, or in publication IPC-7351. They do not guarantee any supposed thermal properties, particularly as these are also strongly influenced by many other parameters.

Still, the given solder pad dimensions will be found adequate for most general applications, e.g. those referring to "standard operation mode". Please note however that applications for "power operation mode" require special considerations for the design of solder pads and adjacent conductor areas.



DESCRIPTION

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of metal alloy is deposited on a high grade (Al₂O₃) ceramic substrate and conditioned to achieve the desired temperature coefficient. Specially designed inner contacts are deposited on both sides. A special laser is used to achieve the target value by smoothly cutting a meander groove in the resistive layer without damaging the ceramics. For the high and low ohmic range, optimized Cermet products provide comparable properties. The resistor elements are covered by a protective coating designed for electrical, mechanical and climatic protection. The terminations receive a final pure tin on nickel plating.

The result of the determined production is verified by an extensive testing procedure and optical inspection performed on 100 % of the individual chip resistors. This includes full screening for the elimination of products with potential risk of early field failures (feasible for $R \geq 10 \Omega$). Only accepted products are laid directly into the paper tape in accordance with IEC 60286-3 ⁽³⁾.

ASSEMBLY

The resistors are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering using wave, reflow or vapour phase as shown in IEC 61760-1. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters and aqueous solutions. The suitability of conformal coatings, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system.

The resistors are RoHS compliant, the pure tin plating provides compatibility with lead (Pb)-free and lead-containing soldering processes. Solderability is specified for 2 years after production or requalification. The permitted storage time is 20 years. The immunity of the plating against tin whisker growth has been proven under extensive testing.

All products comply with the GADSL ⁽¹⁾ and the CEFIC-EECA-EICTA ⁽²⁾ list of legal restrictions on hazardous substances. This includes full compliance with the following directives:

- 2000/53/EC End of Vehicle life Directive (ELV) an Annex II (ELV II)
- 2011/65/EU Restriction of the use of Hazardous Substances Directive (RoHS)
- 2002/96/EC Waste Electrical and Electronic Equipment Directive (WEEE)

Notes

⁽¹⁾ Global Automotive Declarable Substance List, see www.gadsl.org.

⁽²⁾ CEFIC (European Chemical Industry Council), EECA (European Electronic Component Manufacturers Association), EICTA (European trade organisation representing the information and communications technology and consumer electronics), see www.eicta.org/index.php?id=995 → issues → environment policy → chemicals → chemicals for electronics.

⁽³⁾ The quoted IEC standards are also released as EN standards with the same number and identical contents.

APPROVALS

The resistors are approved within the IECQ-CECC Quality Assessment System for Electronic Components to the detail specification EN 140401-801 which refers to EN 60115-1, EN 140400 and the variety of environmental test procedures of the IEC 60068 ⁽³⁾ series. The detail specification refers to the climatic category 55/125/56, which relates to the “standard operation mode” of this datasheet.

Conformity is attested by the use of the CECC logo (Ⓔ) as the mark of conformity on the package label.

Vishay BEYSCHLAG has achieved “Approval of Manufacturer” in accordance with IECQ 03-1. The release certificate for “Technology Approval Schedule” in accordance with CECC 240001 based on IECQ 03-3 is granted for the Vishay BEYSCHLAG manufacturing process.

RELATED PRODUCTS

For more information about products with better TCR and tighter tolerance please refer to the Precision Thin Film Chip Resistors datasheet (www.vishay.com/doc?28700).

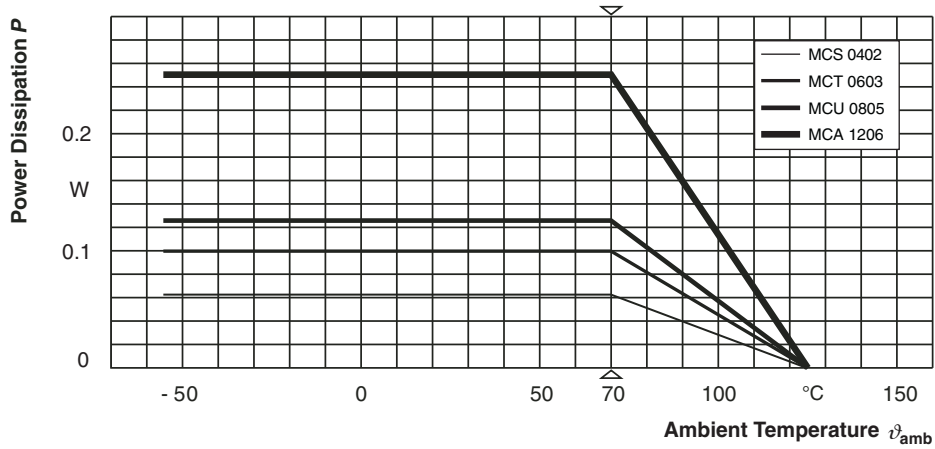
Resistors are available with established reliability in accordance with EN 140401-801 version E. Please refer to the special datasheet (www.vishay.com/doc?28744) for information on failure rate level, available resistance ranges and order codes.

Precision chip resistor arrays may be used in voltage divider applications or precision amplifiers where close matching between multiple resistors is necessary. ACAS 0612 chip arrays are specified by the following datasheets:

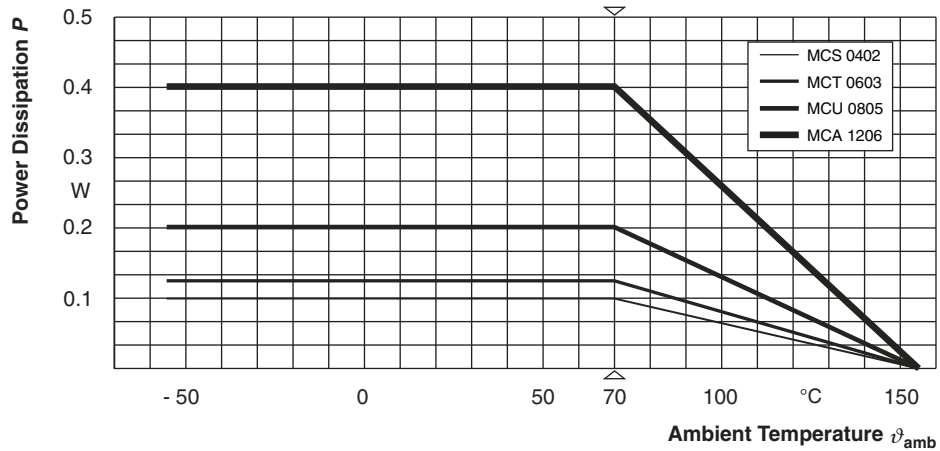
- Professional type (www.vishay.com/doc?28754)
- Precision type (www.vishay.com/doc?28751)



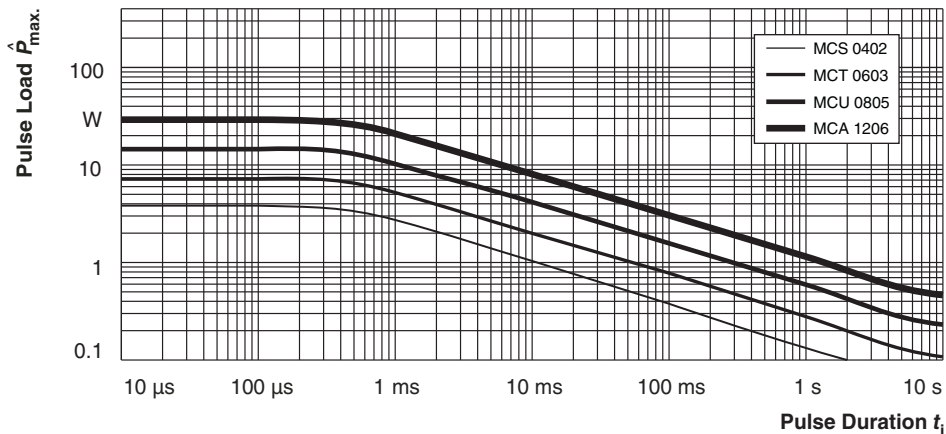
FUNCTIONAL PERFORMANCE



Derating - Standard Operation

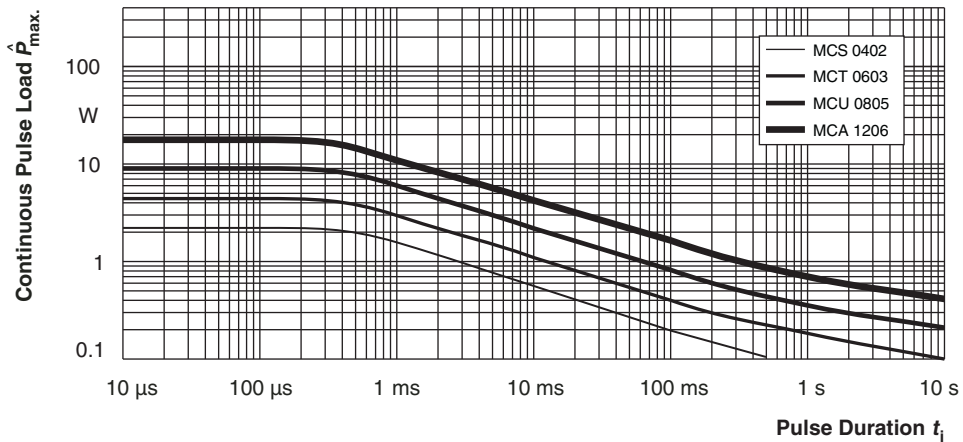


Derating - Power Operation



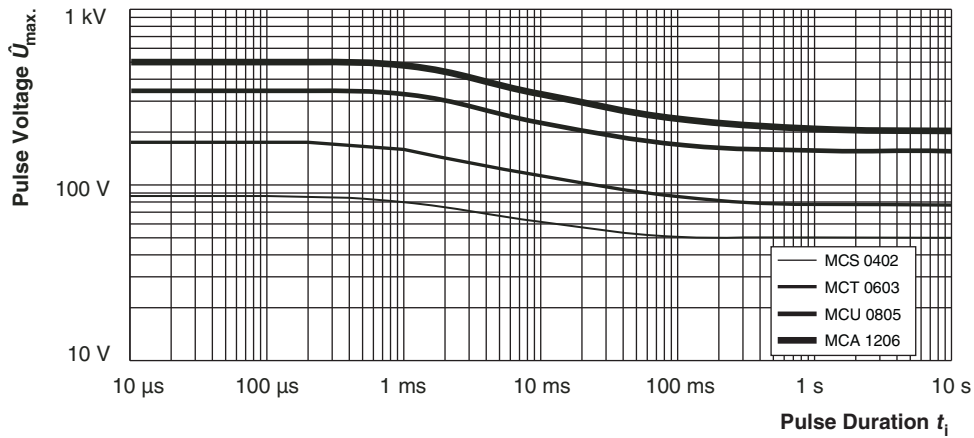
Maximum pulse load, single pulse; applicable if $\bar{P} \rightarrow 0$ and $n \leq 1000$ and $\dot{U} \leq \dot{U}_{max}$;
for permissible resistance change equivalent to 8000 h operation in standard operation mode

Single Pulse



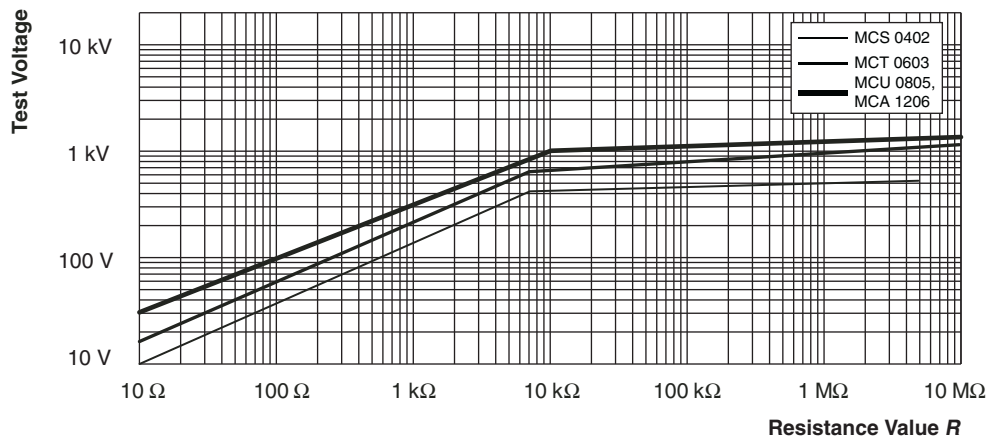
Maximum pulse load, continuous pulses; applicable if $\bar{P} \leq P(\vartheta_{amb})$ and $\hat{U} \leq \hat{U}_{max}$;
for permissible resistance change equivalent to 8000 h operation in standard operation mode

Continuous Pulse



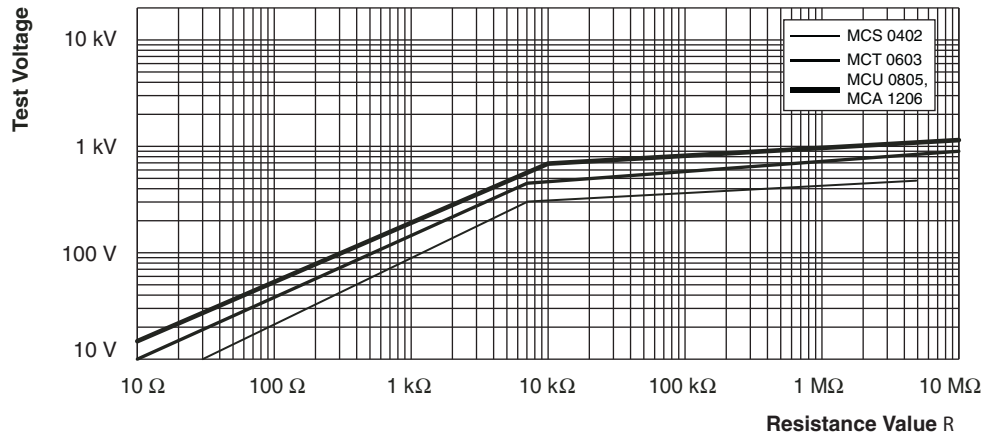
Maximum pulse voltage, single and continuous pulses; applicable if $\hat{P} \leq \hat{P}_{max}$;
for permissible resistance change equivalent to 8000 h operation in standard operation mode

Pulse Voltage



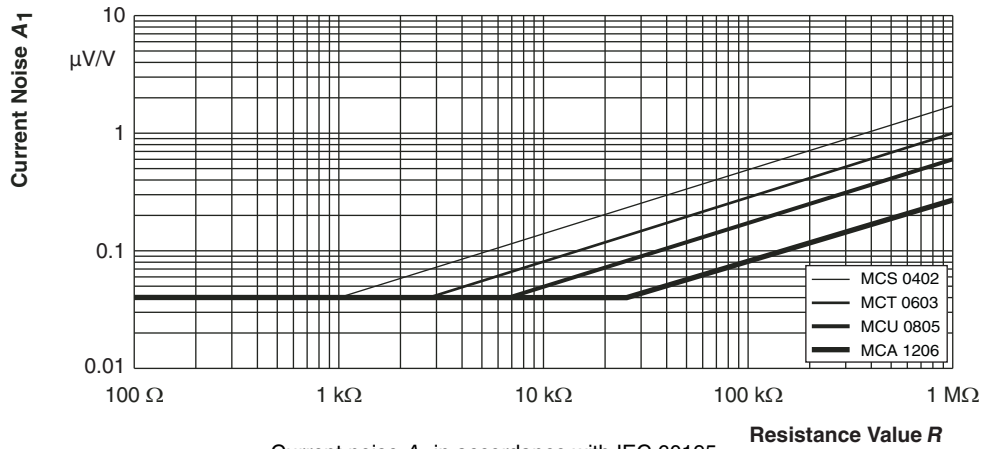
Pulse load rating in accordance with EN 60115-1 clause 4.27; 1.2 μ s/50 μ s; 5 pulses at 12 s interval;
for permissible resistance change $\pm (0.5 \% R + 0.05 \Omega)$

1.2/50 Pulse



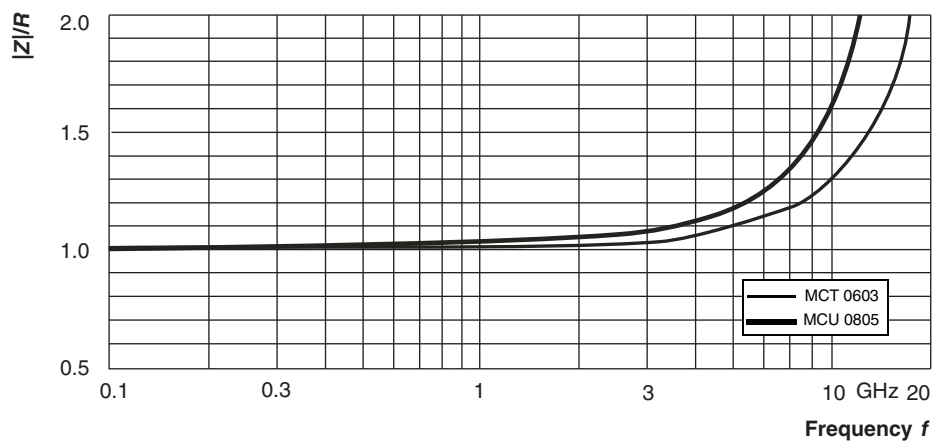
Pulse load rating in accordance with EN 60115-1 clause 4.27; 10 μs/700 μs;
10 pulses at 1 min intervals; for permissible resistance change ± (0.5 % R + 0.05 Ω)

10/700 Pulse



Current noise A₁ in accordance with IEC 60195

Current Noise



|Z|/R for 49.9 Ω chip resistor

RF-Behaviour



TESTS AND REQUIREMENTS

All tests are carried out in accordance with the following specifications:

EN 60115-1, generic specification (includes tests)

EN 140400, sectional specification (includes schedule for qualification approval)

EN 140401-801, detail specification (includes schedule for conformance inspection)

The components are approved in accordance with the European CECC-system, where applicable. The following table contains only the most important tests. For the full test schedule refer to the documents listed above. The testing also covers most of the requirements specified by EIA/IS-703 and JIS-C-5202.

The tests are carried out in accordance with IEC 60068 and under standard atmospheric conditions in accordance with IEC 60068-1, 5.3. Climatic category LCT/UCT/56 (rated temperature range: Lower category temperature, upper category temperature; damp heat, long term, 56 days) is valid.

Unless otherwise specified the following values apply:

Temperature: 15 °C to 35 °C

Relative humidity: 45 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar).

The components are mounted for testing on boards in accordance with EN 60115-1, 4.31 unless otherwise specified.

The requirements stated in the Test Procedures and Requirements table are based on the required tests and permitted limits of EN 140401-801. However, some additional tests and a number of improvements against those minimum requirements have been included.

TEST PROCEDURES AND REQUIREMENTS					
EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)	
				STABILITY CLASS 0.5	STABILITY CLASS 1
			Stability for product types:		
			MCS 0402	10 Ω to 33.2 k Ω	> 33.2 k Ω to 4.99 M Ω
			MCT 0603	10 Ω to 100 k Ω	1 Ω to < 10 Ω ; > 100 k Ω to 10 M Ω
			MCU 0805	10 Ω to 221 k Ω	1 Ω to < 10 Ω ; > 221 k Ω to 10 M Ω
			MCA 1206	10 Ω to 332 k Ω	1 Ω to < 10 Ω ; > 332 k Ω to 2 M Ω
4.5	-	Resistance	-	$\pm 1 \% R$; $\pm 0.5 \% R$	
4.8.4.2	-	Temperature coefficient	At (20/- 55/20) °C and (20/125/20) °C	± 50 ppm/K; ± 25 ppm/K	
4.25.1	-	Endurance at 70 °C: Standard operation mode	$U = \sqrt{P_{70} \times R}$ or $U = U_{max.}$; whichever is the less severe; 1.5 h on; 0.5 h off; 70 °C; 1000 h 70 °C; 8000 h	$\pm (0.25 \% R + 0.05 \Omega)$ $\pm (0.5 \% R + 0.05 \Omega)$	
		Endurance at 70 °C: Power operation mode	$U = \sqrt{P_{70} \times R}$ or $U = U_{max.}$; whichever is the less severe; 1.5 h on; 0.5 h off; 70 °C; 1000 h 70 °C; 8000 h	$\pm (0.5 \% R + 0.05 \Omega)$ $\pm (1 \% R + 0.05 \Omega)$	
4.25.3	-	Endurance at upper category temperature	125 °C; 1000 h	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$
			155 °C; 1000 h	$\pm (0.5 \% R + 0.05 \Omega)$	$\pm (1 \% R + 0.05 \Omega)$
4.24	78 (Cab)	Damp heat, steady state	(40 \pm 2) °C; 56 days; (93 \pm 3) % RH	$\pm (0.5 \% R + 0.05 \Omega)$	$\pm (1 \% R + 0.05 \Omega)$



TEST PROCEDURES AND REQUIREMENTS					
EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)	
				STABILITY CLASS 0.5	STABILITY CLASS 1
			Stability for product types:		
			MCS 0402	10 Ω to 33.2 k Ω	> 33.2 k Ω to 4.99 M Ω
			MCT 0603	10 Ω to 100 k Ω	1 Ω to < 10 Ω ; > 100 k Ω to 10 M Ω
			MCU 0805	10 Ω to 221 k Ω	1 Ω to < 10 Ω ; > 221 k Ω to 10 M Ω
			MCA 1206	10 Ω to 332 k Ω	1 Ω to < 10 Ω ; > 332 k Ω to 2 M Ω
4.23		Climatic sequence: Standard operation mode:			
4.23.2	2 (Ba)	Dry heat	125 °C; 16 h		
4.23.3	30 (Db)	Damp heat, cyclic	55 °C; 24 h; > 90 % RH; 1 cycle		
4.23.4	1 (Aa)	Cold	- 55 °C; 2 h		
4.23.5	13 (M)	Low air pressure	8.5 kPa; 2 h; (25 \pm 10) °C	$\pm (0.5 \% R + 0.05 \Omega)$	$\pm (1 \% R + 0.05 \Omega)$
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; 24 h; > 90 % RH; 5 cycles		
4.23.7	-	DC load	$U = \sqrt{P_{70} \times R} \leq U_{max.};$ 1 min.		
-	1 (Aa)	Cold	- 55 °C; 2 h	$\pm (0.1 \% R + 0.01 \Omega)$	$\pm (0.25 \% R + 0.05 \Omega)$
4.19	14 (Na)	Rapid change of temperature	30 min at LCT and 30 min at UCT; LCT = - 55 °C; UCT = 125 °C; 5 cycles	$\pm (0.1 \% R + 0.01 \Omega)$ no visible damage	
			LCT = - 55 °C; UCT = 125 °C; 1000 cycles	$\pm (0.25 \% R + 0.05 \Omega)$ no visible damage	
4.13	-	Short time overload: Standard operation mode	$U = 2.5 \times \sqrt{P_{70} \times R}$ or $U = 2 \times U_{max.};$ whichever is the less severe; 5 s	$\pm (0.1 \% R + 0.01 \Omega)$	$\pm (0.25 \% R + 0.05 \Omega)$
		Short time overload: Power operation mode	$U = 2.5 \times \sqrt{P_{70} \times R}$ or $U = 2 \times U_{max.};$ whichever is the less severe; 5 s	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$
4.27	-	Single pulse high voltage overload: Standard operation mode	Severity no. 4: $U = 10 \times \sqrt{P_{70} \times R}$ or $U = 2 \times U_{max.};$ whichever is the less severe; 10 pulses 10 μ s/700 μ s	$\pm (0.5 \% R + 0.05 \Omega)$ no visible damage	
4.37	-	Periodic electric overload: Standard operation mode	$U = \sqrt{15 \times P_{70} \times R}$ or $U = 2 \times U_{max.};$ 0.1 s on; 2.5 s off; whichever is the less severe; 1000 cycles	$\pm (0.5 \% R + 0.05 \Omega)$ no visible damage	
		Periodic electric overload: Power operation mode	$U = \sqrt{15 \times P_{70} \times R}$ or $U = 2 \times U_{max.};$ 0.1 s on; 2.5 s off; whichever is the less severe; 1000 cycles	$\pm (1 \% R + 0.05 \Omega)$ no visible damage	



TEST PROCEDURES AND REQUIREMENTS					
EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)	
				STABILITY CLASS 0.5	STABILITY CLASS 1
			Stability for product types:		
			MCS 0402	10 Ω to 33.2 k Ω	> 33.2 k Ω to 4.99 M Ω
			MCT 0603	10 Ω to 100 k Ω	1 Ω to < 10 Ω ; > 100 k Ω to 10 M Ω
			MCU 0805	10 Ω to 221 k Ω	1 Ω to < 10 Ω ; > 221 k Ω to 10 M Ω
			MCA 1206	10 Ω to 332 k Ω	1 Ω to < 10 Ω ; > 332 k Ω to 2 M Ω
4.40	-	Electro static discharge (Human Body Model)	IEC 61340-3-1; 3 pos. + 3 neg. (equivalent to MIL-STD-883, method 3015) MCS 0402: 500 V MCT 0603: 1000 V MCU 0805: 1500 V MCA 1206: 2000 V	$\pm (0.5 \% R + 0.05 \Omega)$	
4.22	6 (Fc)	Vibration	Endurance by sweeping; 10 Hz to 2000 Hz; no resonance; amplitude ≤ 1.5 mm or ≤ 200 m/s ² ; 7.5 h	$\pm (0.1 \% R + 0.01 \Omega)$ no visible damage	
4.17.2	58 (Td)	Solderability	Solder bath method; SnPb40; non-activated flux; (215 \pm 3) $^{\circ}$ C; (3 \pm 0.3) s	Good tinning (≥ 95 % covered); no visible damage	
			Solder bath method; SnAg3Cu0.5 or SnAg3.5; non-activated flux; (235 \pm 3) $^{\circ}$ C; (2 \pm 0.2) s	Good tinning (≥ 95 % covered); no visible damage	
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method; (260 \pm 5) $^{\circ}$ C; (10 \pm 1) s	$\pm (0.1 \% R + 0.01 \Omega)$ no visible damage	$\pm (0.25 \% R + 0.05 \Omega)$ no visible damage
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol + 50 $^{\circ}$ C; method 2	No visible damage	
4.32	21 (Ue ₃)	Shear (adhesion)	RR1005M and RR1608M; 9 N	No visible damage	
			RR2012M and RR3216M; 45 N		
4.33	21 (Ue ₁)	Substrate bending	Depth 2 mm, 3 times	$\pm (0.1 \% R + 0.01 \Omega)$ no visible damage, no open circuit in bent position	
4.7	-	Voltage proof	$U_{RMS} = U_{ins}$; (60 \pm 5) s	No flashover or breakdown	
4.35	-	Flammability	IEC 60695-11-5, needle flame test; 10 s	No burning after 30 s	



HISTORICAL 12NC INFORMATION

- The resistors had a 12-digit numeric code starting with 2312.
- The subsequent 4 digits indicated the resistor type, specification and packaging; see the 12NC table.
- The remaining 4 digits indicated the resistance value:
 - The first 3 digits indicated the resistance value.
 - The last digit indicated the resistance decade in accordance with the last digit of 12NC indicating resistance decade table.

Last Digit of 12NC Indicating Resistance Decade

RESISTANCE DECADE	LAST DIGIT
1 Ω to 9.99 Ω	8
10 Ω to 99.9 Ω	9
100 Ω to 999 Ω	1
1 kΩ to 9.99 kΩ	2
10 kΩ to 99.9 kΩ	3
100 kΩ to 999 kΩ	4
1 MΩ to 9.99 MΩ	5
10 MΩ to 99.9 MΩ	6

Historical 12NC example

The 12NC of a MCT 0603 resistor, value 47 kΩ and TCR 50 with ± 1 % tolerance, supplied in cardboard tape of 5000 units per reel was: 2312 215 14703.

HISTORICAL 12NC - Resistor type and packaging					
DESCRIPTION			2312... ..		
			CARDBOARD TAPE ON REEL		
TYPE	TCR	TOL.	P5 (5000 UNITS)	E0 (10 000 UNITS)	PW (20 000 UNITS)
MCS 0402	± 50 ppm/K	± 1 %	-	275 1....	-
		± 0.5 %	-	275 5....	-
	± 25 ppm/K	± 0.5 %	-	276 5....	-
	Jumper	-	-	275 90001	-
MCT 0603	± 50 ppm/K	± 1 %	215 1....	-	205 1..
		± 0.5 %	215 5....	-	205 5....
	± 25 ppm/K	± 0.5 %	216 5....	-	206 5....
	Jumper	-	215 90001	-	205 90001
MCU 0805	± 50 ppm/K	± 0.5 %	255 5....	-	245 5....
	± 25 ppm/K	± 0.5 %	256 5....	-	246 5....
	Jumper	-	255 90001	-	245 90001



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.